


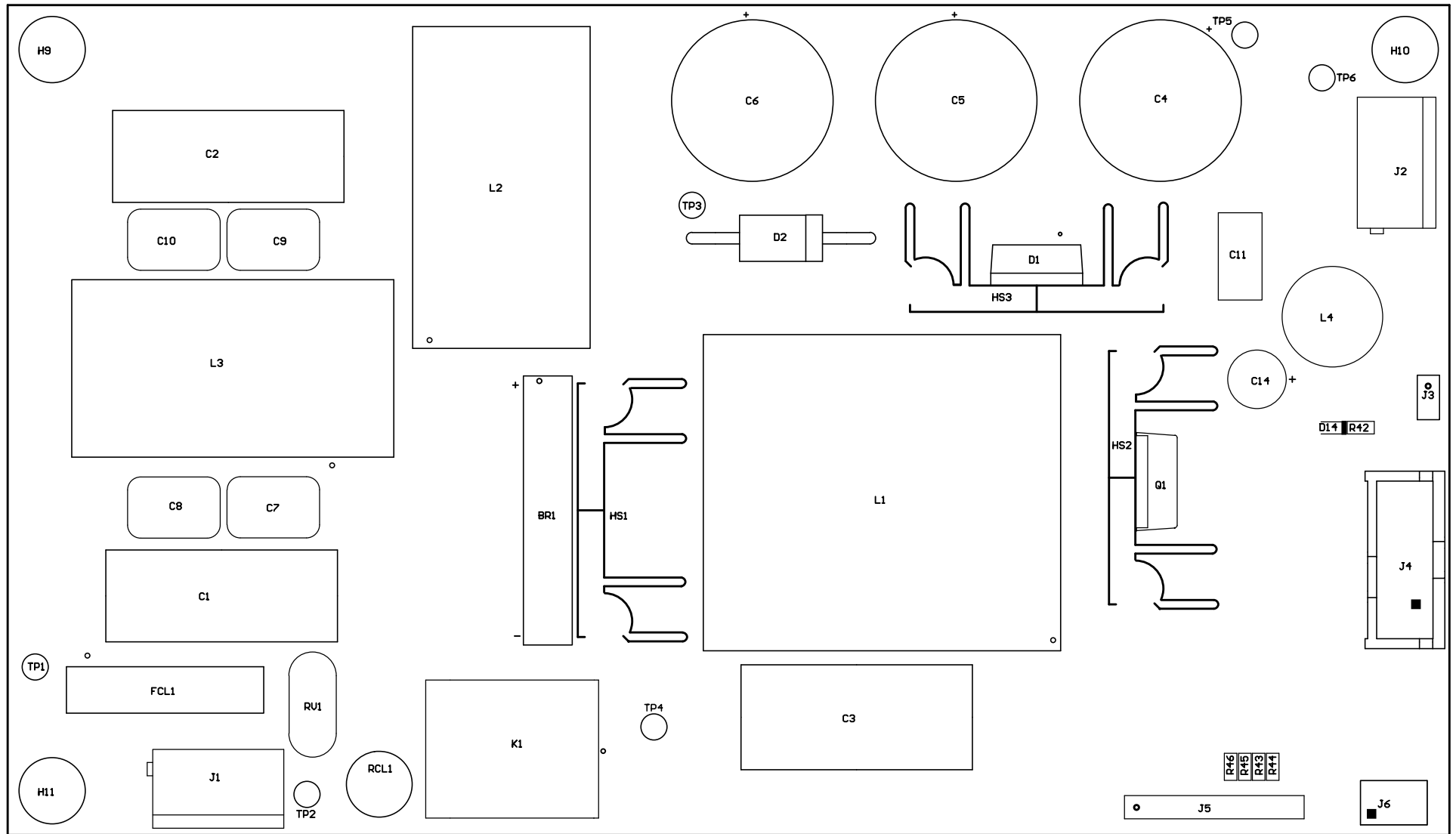


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00477	REV: Rev-B	SUN REV: Not In VersionControl
LAYER NAME = Top Paste			
PLOT NAME = TIDA-00477.GTP	GENERATED : 10/19/2015 1:59:19 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00477	REV: Rev-B	SUN REV: Not In VersionControl
LAYER NAME = Bottom Paste			
PLOT NAME = TIDA-00477.GBP	GENERATED : 10/19/2015 1:59:19 PM	TEXAS INSTRUMENTS	

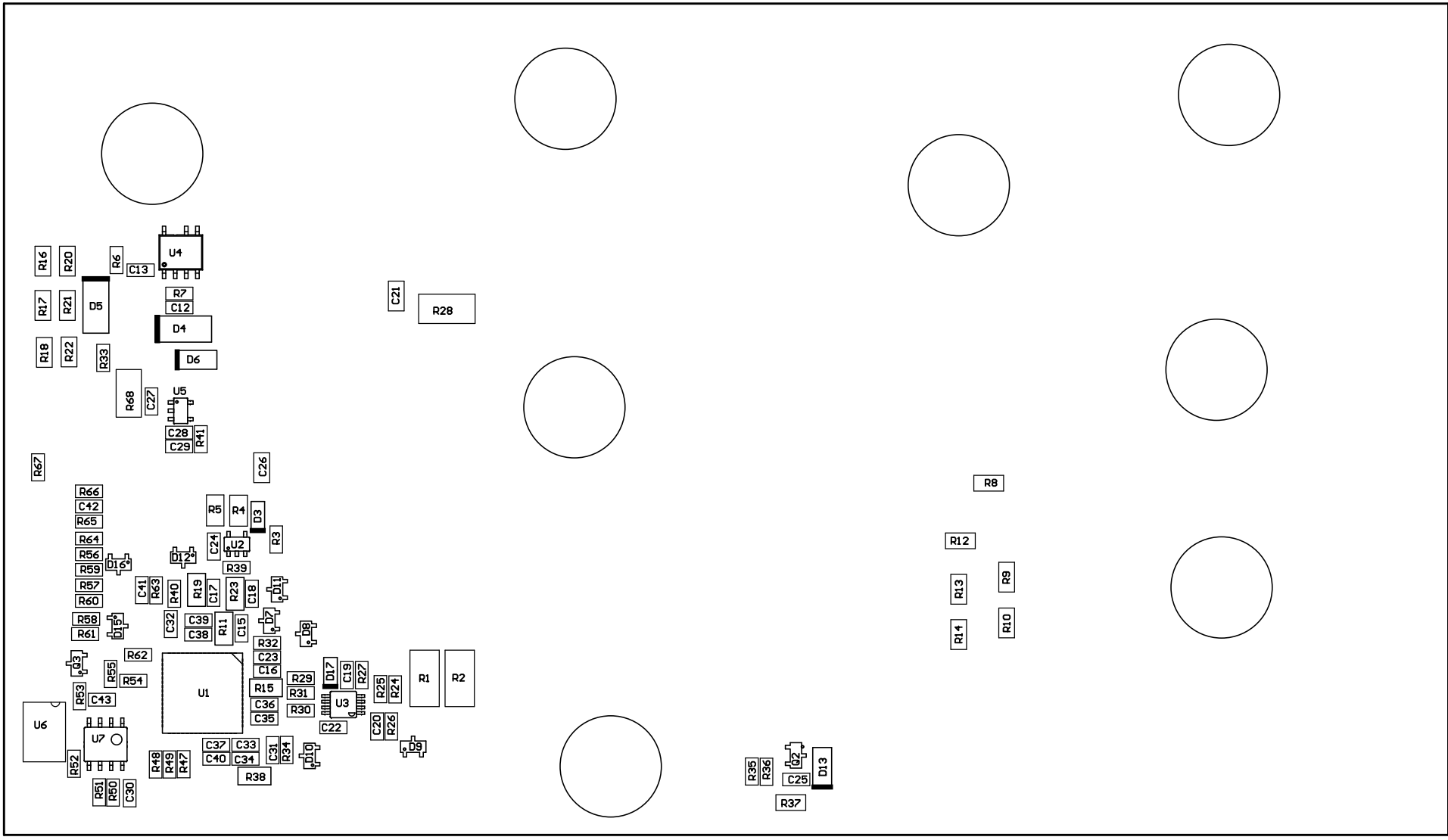
ZZ4 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.  
 ZZ3 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.  
 ZZ2 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.  
 ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

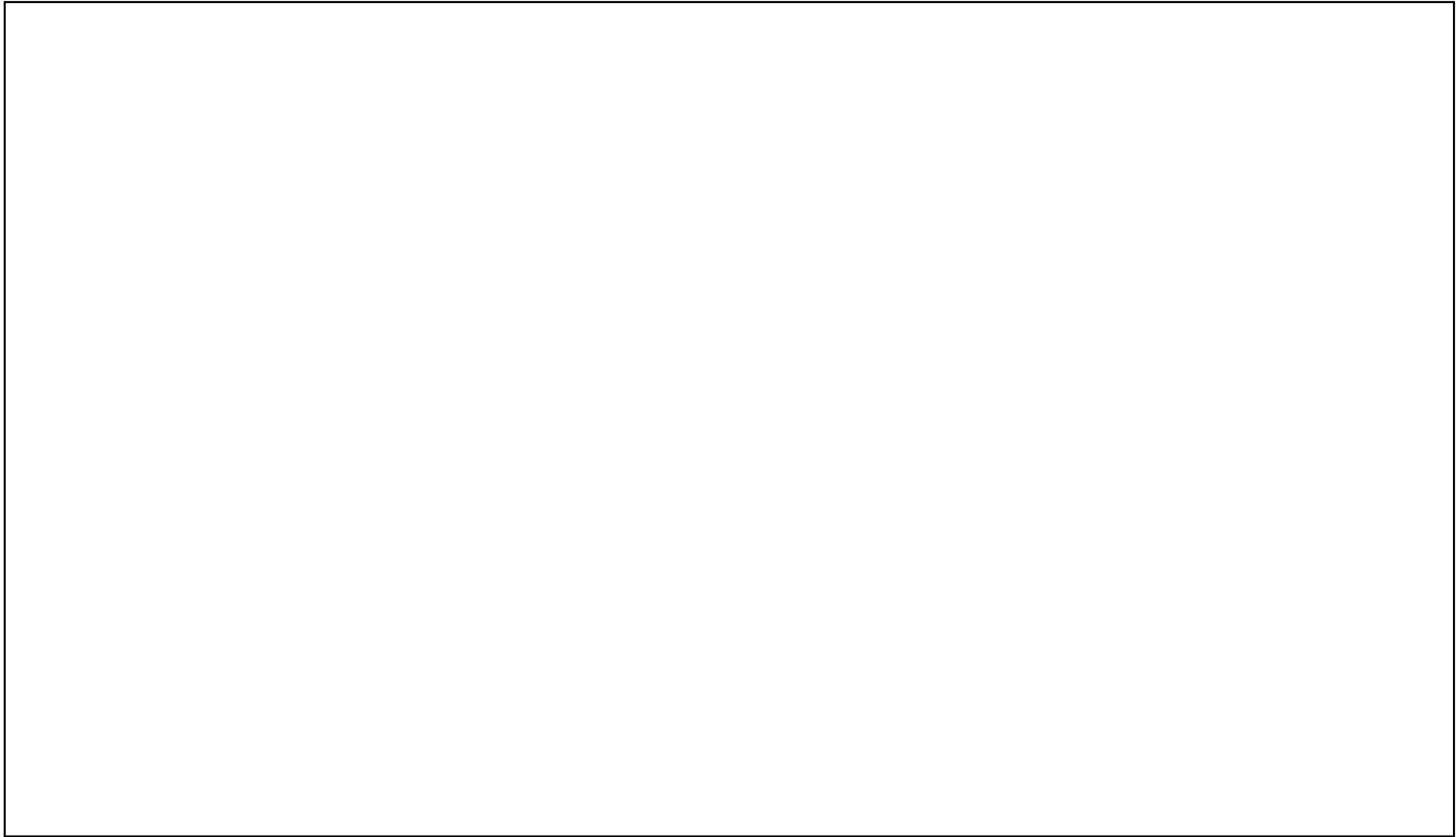


PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00477	REV: Rev-B	SUN REV: Not In VersionControl
<b>M5 Assembly Top</b>			
PLOT NAME = TIDA-00477.GM5	GENERATED : 10/19/2015	2:00:19 PM	TEXAS INSTRUMENTS

PLOT NAME = TIDA-00477.GBR GENERATED : 10/19/2018 5:00:18 PM TEXAS INSTRUMENTS	<b>M6 Assembly Bottom</b>		PCB VIEWED FROM BOTTOM SIDE BOARD #: TIDA-00477 REV: Rev-B SUM REV: Not in VersionControl
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ASSEMBLY VARIANT: [No Variants]  
 COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.





ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00477	REV: Rev-B	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline			
PLOT NAME = TIDA-00477.GM1	GENERATED : 10/19/2015 1:59:19 PM	TEXAS INSTRUMENTS	

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